

# **Approval Sheet**

Products	Dielectric Chip Antenna			
Customer		CALCOMP		
Model		A300		
Customer CODE		SZCC2500P08		
Supplier		PARTRON		
Supplier CODE		KU250		
	By designed	By checked	By approved	
CALCOMP				
	By designed	By checked	By approved	
PARTRON	utto)	Strike	场从	
	Research 5P	Quality Assurance	Laboratory	
	Chanik.Jeon	Nam-Sik. Min	Byoung-Jun.Yim	
	06/26	06/26	06/26	

2009 . 06. 26



22-6, Seokwoo-dong, Hwaseong-si, Gyeonggi-do, 445-170, KOREA

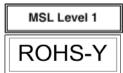
Tel: 82-31-201-7870~6 Fax: 82-31-201-7800 www.partron.co.kr

Ver 0.0 (2009.06.26) 1 / 21 page









# **SPECIFICATION**

MODEL: KU250

## **DIELECTRIC CHIP ANTENNA**

By designed	By checked	By approved
with	Strik	例从
Research 5P	Quality Assurance	Laboratory
Chanik.Jeon	Nam-Sik. Min	Byoung-Jun.Yim
06/26	06/26	06/26

2009 . 06. 26



22-6, Seokwoo-dong, Hwaseong-si, Gyeonggi-do, 445-170, KOREA

Tel: 82-31-201-7870~6 Fax: 82-31-201-7800 www.partron.co.kr

Ver 0.0 (2009.06.26) 2 / 21 page



#### - Contents -

1.	Revision History	4	ķ
2.	Electrical Characteristics	5	ŗ
3.	Mechanical Characteristics	9	ķ
4.	Measurement Process	12	ŗ
5.	Primary Inspection List	13	ŗ
6.	Reliability Condition	14	ŗ
7.	Soldering Condition	15	ŗ
8.	Attention	15	ŗ
9.	Packing	16	ŗ
ın	Process Control	10	





### 1. Revision

Revision No	Originator	Description of changes	Date of changes
Ver 0.0	Chanik.Jeon	Issued	2009.06.26

Ver 0.0 (2009.06.26) 4 / 21 page



#### 2. Electrical Characteristics

#### 2.1 Set Condition

ITEM			SPEC
Fr	equency Range [MHz]	2400 ~ 2485	
	VSWR [Max]		3 : 1
	Bandwidth [MHz]		85
	Polarization		Linear
		Series	1.0nH
	Matching Value of ANT Matching Circuit (Direction, from Antenna to Module)		NC
(Direction, non	ii Anterna to Module)	Shunt2	1.0pF
		Peak	3.15
	Azimuth Plane	Average	0.81
	Flouration 1 Plans	Peak	0.81
Gain[dBi]	Elevation1 Plane	Average	-3.04
Gairi[ubi]		Peak	3.10
	Elevation2 Plane	Average	-3.03
	3D	Peak	3.15
	טפ	Average	-2.22

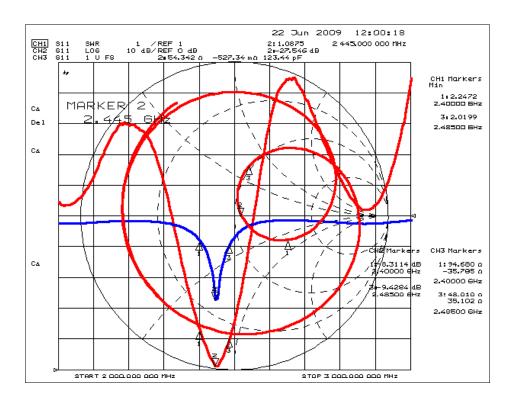
#### 2.2 Test Fixture Condition

ITEM	SPEC
Frequency Range [MHz]	2200 ~ 2280
SWR [Max]	3 : 1
Bandwidth [MHz]	80

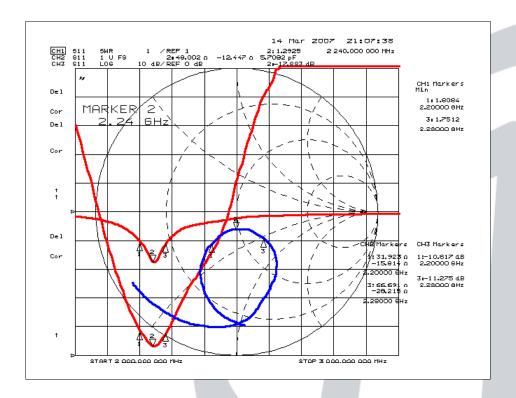
Ver 0.0 (2009.06.26) 5 / 21 page



#### 2.3 Graph of Set Condition



#### 2.4 Graph of Test Fixture Condition

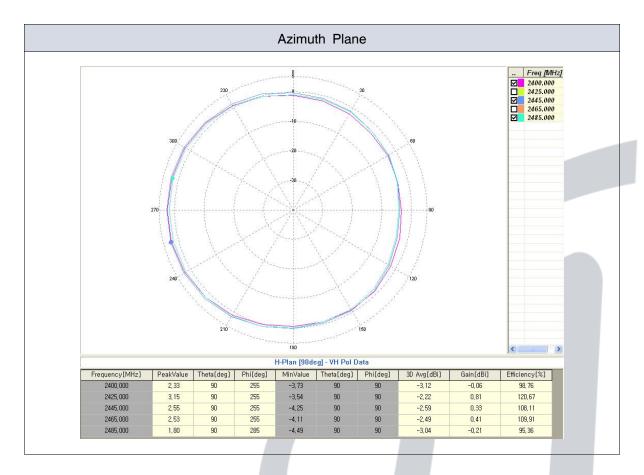


Ver 0.0 (2009.06.26) 6 / 21 page



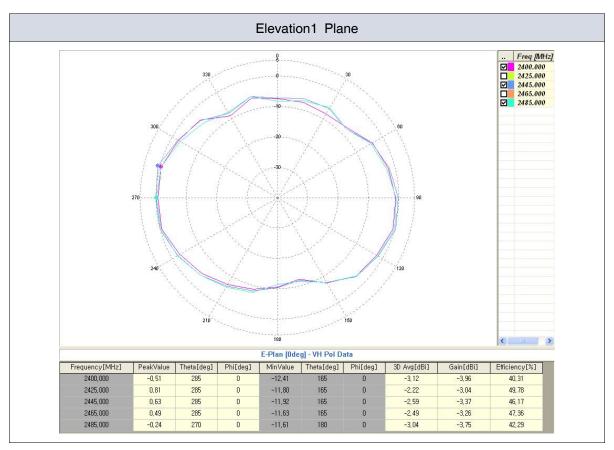
#### 2.5 Radiation Pattern

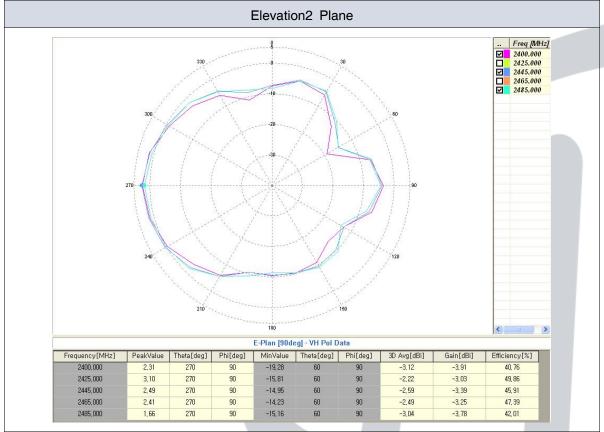
Azimuth Plane	Elevation 1 Plane	Elevation2 Plane
270° 90°	90° 180°	270° — 90° — 90° — 180°



Ver 0.0 (2009.06.26) 7 / 21 page



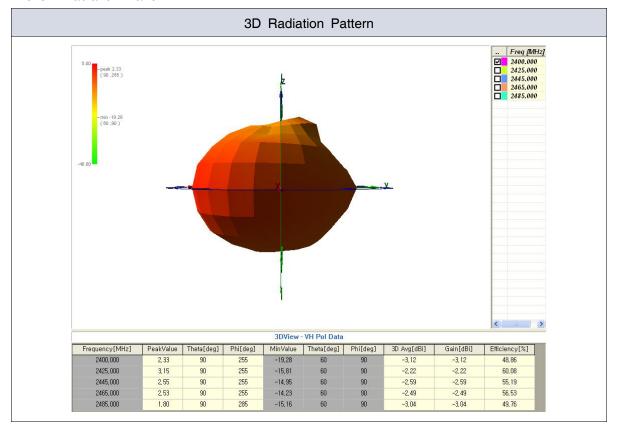




Ver 0.0 (2009.06.26) 8 / 21 page



#### 2.6 3D Radiation Pattern



#### 3. Mechanical Characteristics

- The structure is materialized printing Ag paste at the dielectric block

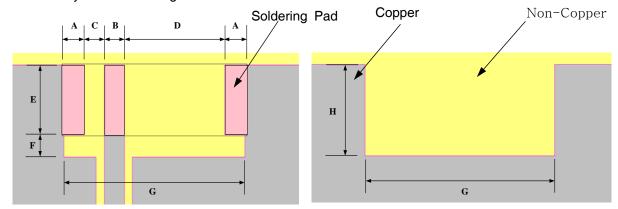
#### 3.1 Structure and Material

Material	Dielectric Block (MMS-08)	3D Structure		
Waterial	Ag Paste (Metech)			
	W = 2.0±0.1	Ag Paste		
Size [mm]	L = 8.0±0.1	Top-Side View Bottom-Side View		
	T = 1.2±0.1	Top-side view Bottom-side view		
Temperature $[^{\circ}C]$		- 40 ~ +80		
Humidity [%]	At the normal temperature, RH 100			

Ver 0.0 (2009.06.26) 9 / 21 page



#### 3.2 PCB Layout & Soldering Pad Dimension

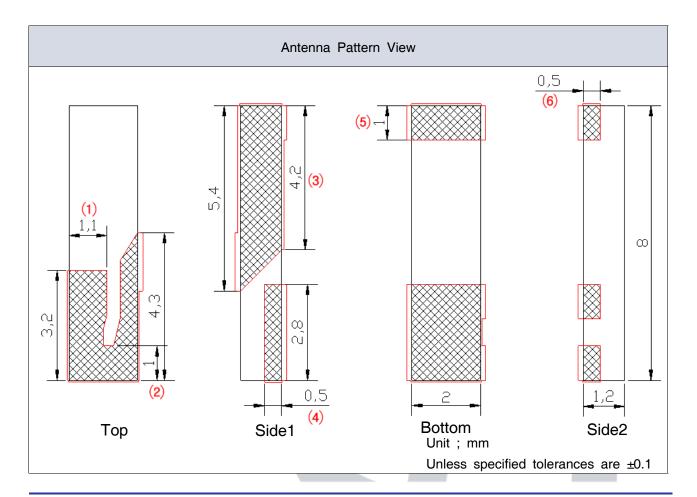


**Top Layout Bottom Pattern** F Parameter В С D Ε G Α Н Value[mm] 1.1 1.0 8.0 4.2 2.2 8.0 3.2 1.0

Unit; mm

Unless specified tolerances are ±0.1

#### 3.3 Antenna Pattern Dimension



Ver 0.0 (2009.06.26) 10 / 21 page



#### 3.3.1 Real Measurement Value

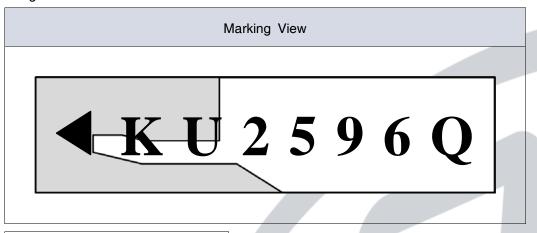
	(1)	(2)	(3)	(4)	(5)	(6)
Drawing Dimension [mm]	1.1±0.1	1.0±0.1	4.2±0.1	0.5±0.1	1.0±0.1	0.5±0.1
1	1.122	0.937	4.161	0.547	1.037	0.522
2	1.073	0.953	4.170	0.530	0.998	0.496
3	1.116	0.945	4.244	0.474	1.042	0.480
4	1.068	0.977	4.223	0.446	1.040	0.449
5	1.081	0.993	4.289	0.432	1.039	0.515
Min [mm]	1.068	0.937	4.161	0.432	0.998	0.449
Max [mm]	1.122	0.993	4.289	0.547	1.042	0.522
Average [mm]	1.092	0.961	4.217	0.486	1.031	0.492

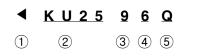
#### 3.4 LOT Notation

9 6 Q 1 2 3

- ① Year; 1 2001, 2 2002, ···· 9 2009 ····
- 2 Month; 1 January, 2 February, ···· 6 June, ···· 12 December
- ③ Date; 1 1st, 2 2nd, 3 3nd, 4 4nd, · · · · 7 7th, · · · · , Q 26th, · · · ·

#### 3.5 Marking





- 1 Input Signal
- 2 Serial
- ③ Year; 1 2001, 2 2002, ···· 9 2009 ····
- 4 Month; 1 January, 2 February, ···· 6 June, ··· 12 December
- 5 Date; 1 1st, 2 2nd, 3 3nd, 4 4nd, .... 7 7th, .... , Q 26th, ....

Ver 0.0 (2009.06.26) 11 / 21 page



#### 4. Measurement Process

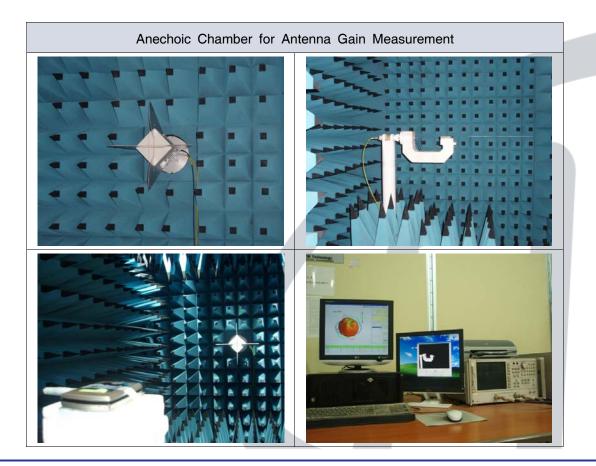
#### 4.1 SWR/Returnloss

-The SWR/Returnloss is measured by Network Analyzer

	Set Condition	Test Fixture Condition
Network Analyzer	Agilent HP8753D	Agilent HP8753D or Advantest R3765CH
Cable	RF cable(300mm)	RF cable(300mm)
Test condition	SEC CECC SCILL CCCCC SCILL CCCCCC SCILL CCCCCC SCILL CCCCCC SCILL CCCCCCC SCILL CCCCCCC SCILL CCCCCCC SCILL CCCCCCC SCILL CCCCCCCCC SCILL CCCCCCCCCC SCILL CCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCCC	C C C C C C C C C C C C C C C C C C C

#### 4.2 Gain

-The Antenna Gain is measured using the set at Anechoic Chamber



Ver 0.0 (2009.06.26) 12 / 21 page



# 5. Primary Inspection List

Item	Electrical Characteristic [MHz]		М	Mechanical Dimension [mm]		
0	VSWR Max		W 00 04	1 00 04	T=1.2±0.1	
Standard	MHz	MHz	W=2.0±0.1	L=8.0±0.1	<b>€TO</b>	
1						
2						
3						
4						
5						
6						
7						
8						
9						
10						
11						
12						
13						
14						
15						
16						
17						
18						
19						
20						
Х						
σ						
Cpk						
Decision						

Ver 0.0 (2009.06.26) 13 / 21 page



#### 6. Reliability Condition

#### 6.1 ENVIRONMENT TEST

ITEM	TEST CONDITION	LIMIT	
High Temperature	+85℃±3℃, 120hr±2hr	*After the test,	
Resistance	+65 ○±3 ○, 120111±2111	specimen would be kept at	
Low Temperature	-40℃±3℃,120hr±2hr	25°C±5°C for 1 hours	
Resistance	-40 0±3 0 , 120HI±2HI		
Humidity Resistance	+60±3℃, RH90~95% ,120hr±2hr	*specimen sheet meet the electrical specification	

#### 6.2 Thermal Shock Test , Reflow Test

ITEM	TEST CONDITION	LIMIT
	-40 °C ±3 °C /30min ↔ +85 °C ±3 °C /30min	
Thermal Shock	cycle: 15 cycle	
	recovery time: with in 5min	SAME as 6-1
Defless	Pre Heating 200±5℃, 30~60 sec	
Reflow	Peak Heating 260℃±5℃, 30sec Max	

#### 6.3 Mechanical Test

ITEM	TEST CONDITION	LIMIT
Random Vibration	Frequency 10~500Hz - 10 ×9.8 m/s²(G) Sweep time 15min , X.Y.Z each 5 times	*After the test, specimen sheet meet the
Drop	Height 152cm , 5 times (Each Surface)	electrical specification

#### 6.4 Reliability Test Result

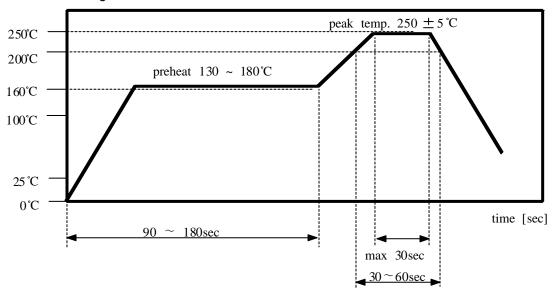
\* Appendix





#### 7. Soldering Condion

#### 7.1 Reflow Soldering



#### 7.2 Manual Soldering

Soldering Temperature :  $340\,^{\circ}\text{C}\,\pm\!5\,^{\circ}\text{C}$  , 5sec max per each terminal

#### 8. Attention

#### 8.1 Temperature Condition

	Range of Temperature	unit
Application	-40 ~ +85	J
Keeping	-40 ~ +85	°C

#### 8.2 MSL LEVEL 1 (JEDEC J-STD-020C)

	FI	oor Life	Soak Requirements					
	Time	Conditions	Time	Conditions				
1	Unlimited	= < 30°C/85%RH	168+5/-0	= < 85℃/85%RH				

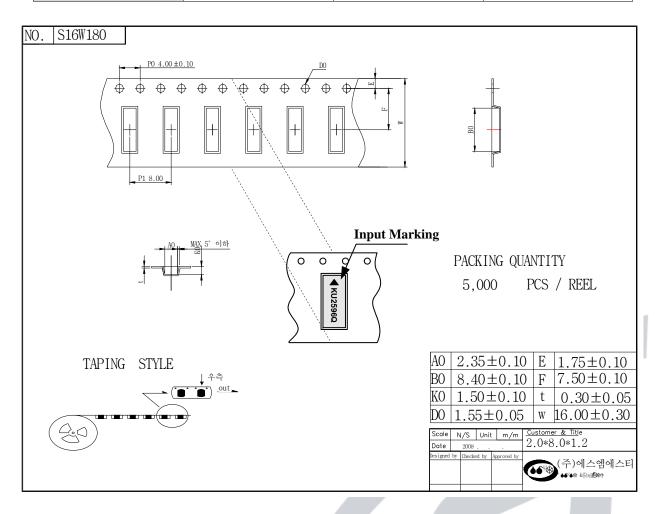
Ver 0.0 (2009.06.26) 15 / 21 page



#### 9. Packing

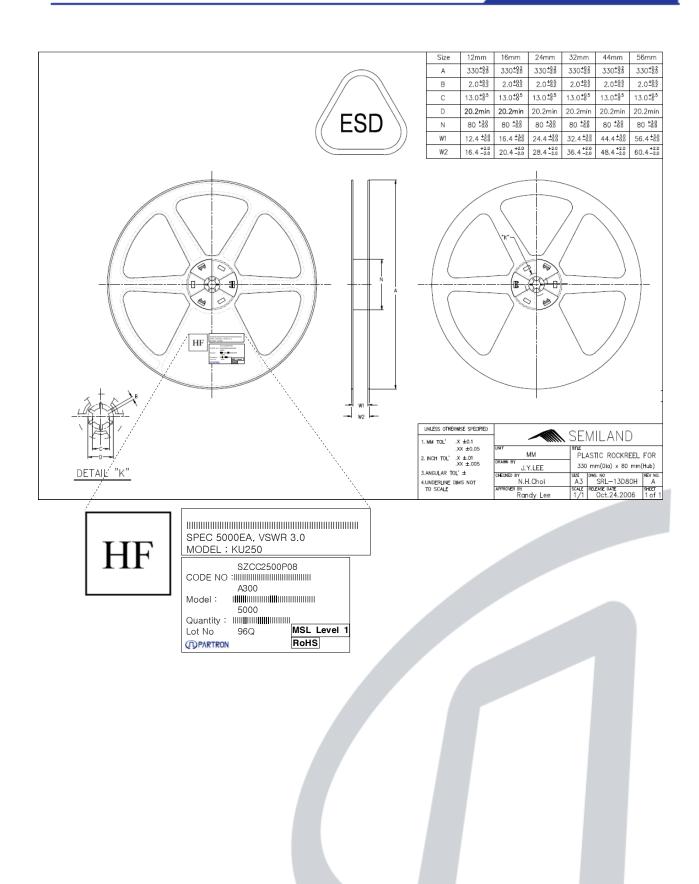
#### 9.1 Carrier/Reel

ITEM	Material	Surface Resistance	Packing Method
Carrier	A-PET	Typical 10 <sup>8</sup> Ω	Heat press
Reel	A-PET		Air press (Using S-460G)



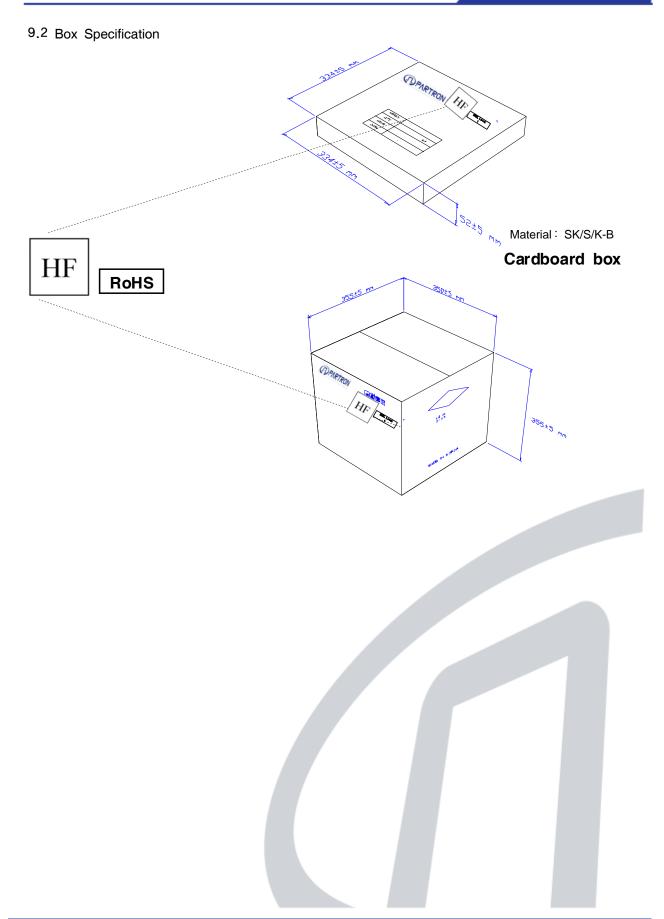
Ver 0.0 (2009.06.26) 16 / 21 page





Ver 0.0 (2009.06.26) 17 / 21 page





Ver 0.0 (2009.06.26) 18 / 21 page



#### 10. Process Control

Product			lss	sued/Revision	1					Record	By designe	d By chec	ked By	approved
CHIP ANTENNA		Issued Revise			Process Control					01				
Input	FLOW	CHART	Process		Mana	gement of Facto	rs			M	anagement of qua	lity		
Materials	prepar ation	Main Process	name	Equipment Name	Checked	Condition	Cycle of management	Record	Checked Item	Margin	Method of Inspection	Cycle of management	Record	Action
Ceramic POWDER			Import Inspection						shrinking rate permittivity	refer to Guide Sheet	Micrometer Network	10ea/L0T	C/sheet	Return
POWDER lubricant			powder	Mixer					mixing	POWDER lubricant	Scale	PER MIXING	-	Exhaust
			Shaping	Press	pressure Mold Conditi		Per LOT 1/day	parameter C/SHEET	dimension weight density aspect	refer to Guide Sheet	Micrometer scale Calculated Visual	5/100EA 10ea/lot	LOT CARD	Exhaust
			Plasticity	Plasticity Hole	SETTER Outsi Temperature PROFILE	refer to	all 2/day 1/month	C/sheet						
			Block						wide length shape	refer to Guide Sheet	Micrometer Calipers Visual Inspection	20ea/L0T 20ea/L0T all	C/sheet	Exhaust
AG PASTE			SIDE1 PAD Printing	Printer screen	Squeeze velocity/pres SNAP	refer to Guide Sheet	1/day	-	PATTERN Dimension aspect	refer to Guide Sheet	Microscope	10ea/3Jig	c/sheet	Rework
			Dry	Dryer Dry Jig	Temperatu Belt spee	0:-1- 0+	1/week	Parameter	Dry Condition  Printed condition breakage	refer to Guide Sheet	Visual Inspection	all	Lot	Rework

Ver 0.0 (2009.06.26)



Product CHIP ANTENNA		Is	sued/Revision	า							By designed	By chec	ked By	approved	
		Issue Revise			Process Control					PRCP-C0	01				
Input	FLOW	CHART	Process		N	Managem	ent of Factor	S			N	Management of qua	lity		
Materials	prepar ation	Main Process	name	Equipment Name	Chec	cked	Condition	Cycle of management	Record	Checked Item	Margin	Method of Inspection	Cycle of management	Record	Action
AG PASTE			SIDE 2 PAD Printing	Printer screen	Sque velocity, SN	eeze /presure AP	e refer to 1/week		-	PATTERN Dimension aspect	refer to Guide Sheet	Microscone		c/sheet	Rework
			Dry	Dryer Dry Jig	Temper Belt				Parameter	Dry Condition  Printed condition breakage	refer to Guide Sheet	Visual Inspection	all	Lot card	Rework
			Baking	Baking Hole mesh net	Temper Belt	ature speed	refer to Guide Sheet	1/week	Parameter C/Sheet	Breakage Pollution	refer to Guide Sheet	Visual Inspection	all	Lot card	Exhaust Rework
AG PASTE			TOP printing	Printer screen	Sque velocity SN	eeze /presure AP	refer to Guide Sheet	1/day	-	PATTERN dimension	refer to Guide Sheet	measure	10ea/3Jig	c/sheet	Rework
			Dry	Dryer Dry Jig	Temper Belt		refer to Guide Sheet	1/week	Parameter	Dry Condition  Printed condition breakage	refer to Guide Sheet	Visual Inspection	all	Lot card	Rework
AG PASTE			BOTTOM PAD Printing CTQ	printer screen	Sque velocity, SN	eeze /presure AP	refer to Guide Sheet	1/day	-	PATTERN dimension aspect	refer to Guide Sheet	measure Microscope	10ea/3Jig	c/sheet	Rework

Ver 0.0 (2009.06.26)



Product CHIP ANTENNA			ssued/Revisio	n							d	By design	ed By che	ecked By	approved	
			Issued 04.04 Revised 05.04			Pro	PRCP-C	001								
Input	FLOW	CHART	Process		ı	Manager	ment of Facto	rs			1	Managem	ent of qua	lity		
Materials	prepar ation	Main Process	name	Equipment Name	Chec	cked	Condition	Cycle of management	Record	Checked Item	Margin		thod of pection	Cycle of management	Record	Action
			Dry	Dryer Dry Jig	Temper Belt		refer to Guide Sheet	1/week	Parameter	Dry Condition Printed condition breakage	refer to Guide Sheet	Visual	Inspection	all	Lot card	d Rework
			Baking	Baking Hole mesh net	Temper Belt	ature speed	refer to Guide Sheet	1/week	Parameter C/Sheet	Breakage Pollution	refer to Guide Sheet	Visual	Inspection	all	Lot card	Exhaust Rework
			aspect inspectio	1						aspect	Reference SPL refer to Guide Sheet		Inspection roscope	all	Lot card	
			MARKING	Marking Machine						marking	Reference SPL	Visual	Inspection	all	Lot card	
			Electrical Characterist	NETWORK Inspection Jig	proofr Cond		refer to Guide Sheet	1/2hour	C/sheet	Electrical Characteristic	refer to Guide Sheet	N€	etwork	all	Lot card	d Exhaust repair
			aspect inspectio	า						aspect dimension	Reference SPL refer to Guide Sheet		Inspection roscope	all	Lot card production diary	
Carrier cover reel			Taping							Quantity Direction aspect	refer to Guide Sheet	M	anua l	all	Lot card	
			shipper inspectio	NETWORK Inspection Jig	proofr Cond		refer to Guide Sheet	1/person	C/sheet	Electrical Characteristic aspect packing	refer to Guide Sheet	mic	etwork roscope Inspection	refer to Guide Sheet	Result Paper	return Exhaust
packing box label			packing	bar code printer						packing P/N Quantity	refer to Guide Sheet	Visual	Inspection	all	_	Rework
			packing inspectio	า						packing P/N Quantity	refer to Guide Sheet	Visual	Inspection	all	_	return

Ver 0.0 (2009.06.26)